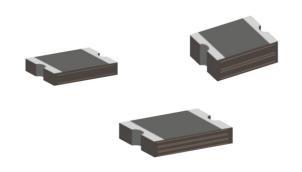


# SMD2920P Series POSITIVE THERMAL COEFFICIENT(PTC)

#### Description

The 2920 series provides surface mount resettable over-current protection with holding current from 0.3A to 3.0A. This series is suitable for applications with higher holding currant and higher working voltage up to 60V.



#### **Features**

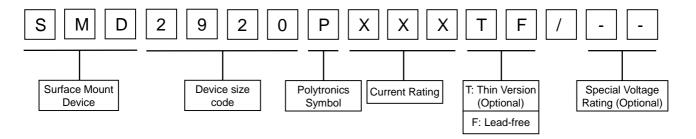
- I I(hold): 0.3~ 30A
- I Very high voltage surge capabilities
- I Available in lead-free version
- I Fast response to fault current
- I RoHS compliant, Lead- Free and Halogen-Free
- I Low resistance
- I Compact design saves board space
- I Compatible with high temperature solders

#### **Applications**

- I USB peripherals
- I Disk drives
- I CD-ROMs
- I General electronics
- I Disk drives
- I Set-top-box and HDMI
- Mobile Internet Device (MID)

- I PDAs / digital cameras
- I Game console port protection
- Plug and play protection for motherboards and peripherals
- Mobile phones battery and port protection

#### **Part Number Code**



#### **Environmental Specifications**

Test	Test Conditions	Accept/Reject Criteria
Resistance	In still air @ 25 ℃	$R_{min} \leq R \leq R_{max}$
Time to Trip	Specified current, V <sub>max</sub> , 25°C	T≤maximum Time to Trip
Hold Current	30min, at I <sub>H</sub>	No trip
Trip Cycle Life	Vmax, Imax, 100cycles	No arcing or burning
Trip Endurance	Vmax, 1 hours	No arcing or burning



## Physical Characteristics and Environmental Specifications

Terminal materials:	Tin-Plated Nickle-copper						
Soldering zone	Meets EIA specification RS 186-9	Meets EIA specification RS 186-9E and ANSI/J-STD-002 Category 3.					
Environmental Specification	ons						
Test	Conditions	Resistance Change					
Passive aging	85℃,1000hours	±10%					
Humidity aging	85°C/85%RH.1000 hours ±5%						
Thermal shock	MIL-STD-202,Method 107G	-30% typical resistance change					
	+85°C/-40°C,20times						
Solvent Resistance	MIL-STD-202,Method 215	no change					
Vibration	ML-STD-883C,Test Condition A	No change					

## Electrical Characteristic

	$V_{Max}$	I <sub>Max</sub>	I <sub>Hold</sub>	$I_{Trip}$	$P_{\scriptscriptstyle D}$	Maximum Time-to-trip		Resistance	
Part Number	()(da)	(4)	(4)	(4)	Max.	Current	Time	R <sub>Min</sub>	R1 <sub>Max</sub>
	(Vdc)	(A)	(A)	(A)	(W)	(A)	(Sec)	(Ω)	(Ω)
SMD2920P030TF	60	100	0.30	0.60	1.5	1.5	3.0	0.60	4.80
SMD2920P050TF	60	100	0.50	1.00	1.5	2.5	4.0	0.18	1.40
SMD2920P075TF	33	100	0.75	1.50	1.5	8.0	0.3	0.10	1.00
SMD2920P100TF	33	100	1.00	2.20	1.5	8.0	0.5	0.065	0.41
SMD2920P125TF	33	100	1.25	2.50	1.5	8.0	2.0	0.05	0.25
SMD2920P150TF	33	100	1.50	3.00	1.5	8.0	2.0	0.035	0.23
SMD2920P185TF	33	100	1.85	3.70	1.5	8.0	2.5	0.030	0.15
SMD2920P200TF	16	100	2.00	4.00	1.5	8.0	4.5	0.020	0.12
SMD2920P200TF/24	24	100	2.00	4.00	1.5	8.0	4.5	0.020	0.12
SMD2920P250TF	16	100	2.50	5.00	1.5	8.0	16.0	0.020	0.085
SMD2920P260TF	16	100	2.60	5.20	1.5	8.0	10.0	0.014	0.075
SMD2920P300TF/6	6	100	3.00	6.00	1.5	8.0	20.0	0.012	0.048
SMD2920P300TF/16	16	100	3.00	6.00	1.5	8.0	20.0	0.012	0.048

V<sub>max</sub> = Maximum operating voltage vice can withstand without damage at rated current (Imax).

 $I_{max}$  = Maximum fault current device can withstand without damage at rated voltage (V max).

I hold = Hold Current. Maximum current device will not trip in 25°C still air.

I trip = Trip Current. Minimum current at which the device will always trip in 25°C still air.

 $P_d$  = Power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.

Ri <sub>min/max</sub> = Minimum/Maximum device resistance prior to tripping at 25°C.

 $R1_{max}$  = Maximum device resistance is measured one hour post reflow.

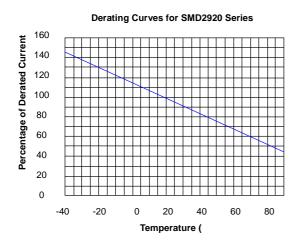


## Thermal Derating Chart-I<sub>H</sub> ( A )

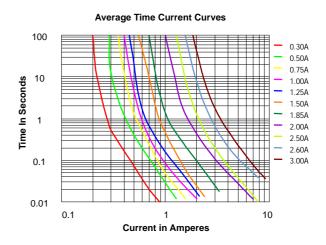
Part Number -			Maximu	m ambient	operating	temperatu	res (°C)		
rait Number	-40	-20	0	25	40	50	60	70	85
SMD2920P030TF	0.44	0.37	0.35	0.30	0.28	0.23	0.20	0.18	0.14
SMD2920P050TF	0.73	0.62	0.59	0.50	0.47	0.38	0.34	0.30	0.24
SMD2920P075TF	1.09	0.92	0.88	0.75	0.70	0.56	0.50	0.45	0.36
SMD2920P100TF	1.45	1.23	1.17	1.00	0.93	0.75	0.67	0.60	0.48
SMD2920P125TF	1.81	1.54	1.46	1.25	1.16	0.94	0.84	0.75	0.60
SMD2920P150TF	2.18	1.85	1.76	1.50	1.40	1.13	1.01	0.90	0.72
SMD2920P185TF	2.68	2.28	2.16	1.85	1.72	1.39	1.24	1.11	0.89
SMD2920P200TF	2.90	2.46	2.34	2.00	1.86	1.50	1.34	1.20	0.96
SMD2920P200TF/24	2.90	2.46	2.34	2.00	1.86	1.50	1.34	1.20	0.96
SMD2920P250TF	3.63	3.08	2.93	2.50	2.33	1.88	1.68	1.50	1.20
SMD2920P260TF	3.77	3.20	3.04	2.60	2.42	1.95	1.74	1.56	1.25
SMD2920P300TF/6	4.35	3.69	3.51	3.00	2.79	2.25	2.01	1.80	1.44
SMD2920P300TF/16	4.35	3.69	3.51	3.00	2.79	2.25	2.01	1.80	1.44



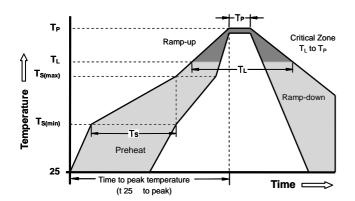
## **Thermal Derating Curve**



## **Average Time-Current Curve**



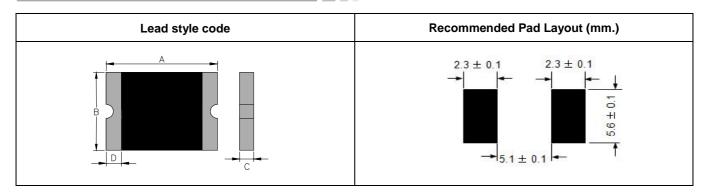
## Soldering Parameters



Reflow	Condition	Pb - Free assembly
	-Temperature Min (T <sub>s(min)</sub> )	150°C
Pre Heat	-Temperature Max (T <sub>s(max)</sub> )	200°C
	- Time (min to max) (t <sub>s</sub> )	60 -180 Seconds
	e ramp up rate ( Liquids _) to peak	3°C/second max
T <sub>S(max)</sub> to	TL - Ramp-up Rate	3°C/second max
Reflo	- Temperature (T <sub>L</sub> ) (Liquids)	217°C
V	- Time (min to max) (t <sub>s</sub> )	60 -150 Seconds
Peak Te	mperature (T <sub>P</sub> )	260 +0/-5°C
	thin 5°C of actual peak ature (t <sub>p</sub> )	20 - 40 Seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T <sub>P</sub> )		8 minutes Max
Do not e	exceed	260°C



## Recommended Pad Layout (mm)



## Product Dimensions

## Unit: mm

Doub Noveleau	Marking	I	<b>\</b>	I	В	(	С	D	E
Part Number	Marking	Max	Min	Max	Min	Max	Min	Min	Min
SMD2920P030TF	030L	6.73	7.98	4.80	5.44	0.60	1.15	0.30	0.15
SMD2920P050TF	050L	6.73	7.98	4.80	5.44	0.60	1.15	0.30	0.15
SMD2920P075TF	075L	6.73	7.98	4.80	5.44	0.60	1.15	0.30	0.15
SMD2920P100TF	100L	6.73	7.98	4.80	5.44	0.60	1.00	0.30	0.15
SMD2920P125TF	125L	6.73	7.98	4.80	5.44	0.60	1.00	0.30	0.15
SMD2920P150TF	150L	6.73	7.98	4.80	5.44	0.60	1.20	0.30	0.15
SMD2920P185TF	185L	6.73	7.98	4.80	5.44	0.60	1.20	0.30	0.15
SMD2920P200TF	200L	6.73	7.98	4.80	5.44	0.40	0.80	0.30	0.15
SMD2920P200TF/24	200L	6.73	7.98	4.80	5.44	0.60	1.20	0.30	0.15
SMD2920P250TF	250L	6.73	7.98	4.80	5.44	0.40	0.80	0.30	0.15
SMD2920P260TF	260L	6.73	7.98	4.80	5.44	0.40	0.80	0.30	0.15
SMD2920P300TF/6	300L	6.73	7.98	4.80	5.44	0.40	0.80	0.30	0.15
SMD2920P300TF/16	300L	6.73	7.98	4.80	5.44	0.60	1.20	0.30	0.15



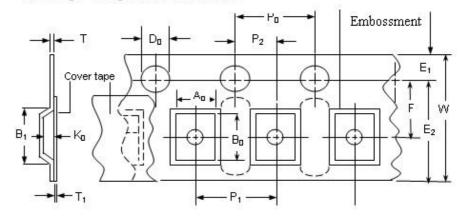
## Taping and Reel Specifications

<b>Covering Specifications</b>					
EIA 481-1(Unit:mm)					
W	16± 0.3				
P <sub>0</sub>	4.0 ± 0.10				
P <sub>1</sub>	8.0 ± 0.10				
P <sub>2</sub>	2.0 ± 0.10				
A <sub>0</sub>	5.74 ± 0.10				
B <sub>0</sub>	8.02 ± 0.10				
D <sub>0</sub>	1.55 ± 0.05				
F	7.5± 0.10				
E <sub>1</sub>	1.75 ± 0.10				
Т	0.20± 0.10				
Leader min.	390				
Trailer min.	160				
Reel Dimensions					
Α	178± 1				
N	58± 1				

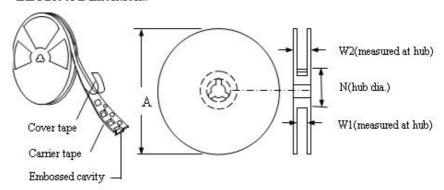
16.9± 0.80

19.3± 0.1

#### **EIA Tape Component Dimentions**



#### **EIA Reel Dimentions**



# **Packaging Quantity**

 $W_1$ 

 $W_2$ 

Quantity		1500	20	000
	SMD2920P185TF	SMD2920P300TF/16	SMD2920P030TF	SMD2920P150TF
		SMD2920P200TF/24	SMD2920P050TF	SMD2920P200TF
Part Number			SMD2920P075TF	SMD2920P250TF
			SMD2920P100TF	SMD2920P260TF
			SMD2920P125TF	SMD2920P300TF

# 单击下面可查看定价,库存,交付和生命周期等信息

# >>SUNMATE(森美特)